

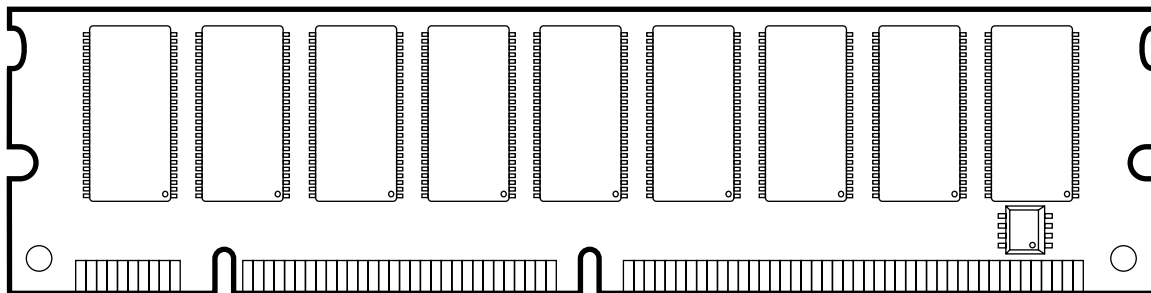
**3.3 VOLT 16M x 72 HIGH PERFORMANCE
UNBUFFERED ECC SDRAM MODULE**
Features

- 168 Pin Unbuffered 16,777,216 x 72 bit Organization SDRAM ECC DIMMs
- Utilizes High Performance 128 Mbit, 16M x 8 SDRAM in TSOPII-54 Packages
- Fully PC Board Layout Compatible to INTEL'S Rev 1.0 Module Specification
- Single +3.3V ($\pm 0.3V$) Power Supply
- Programmable CAS Latency, Burst Length, and Wrap Sequence (Sequential & Interleave)
- Auto Refresh (CBR) and Self Refresh
- All Inputs, Outputs are LVTTTL Compatible
- 4096 Refresh Cycles every 64 ms
- Serial Present Detect (SPD)
- SDRAM Performance

Description

The V437316S04V memory module is organized 16,777,216 x 72 bits in a 168 pin dual in line memory module (DIMM). The 16M x 72 memory module uses 9 Mosel-Vitellic 16M x 8 SDRAM. The x72 modules are ideal for use in high performance computer systems where increased memory density and fast access times are required.

Part Number	Speed Grade	Configuration
V437316S04VXTG-75PC	-75PC, CL=2,3 (133 MHz)	16M x 72
V437316S04VXTG-75	-75, CL=3 (133 MHz)	16M x 72
V437316S04VXTG-10PC	-10PC, CL=2,3 (100 MHz)	16M x 72



Pin Configurations (Front Side/Back Side)

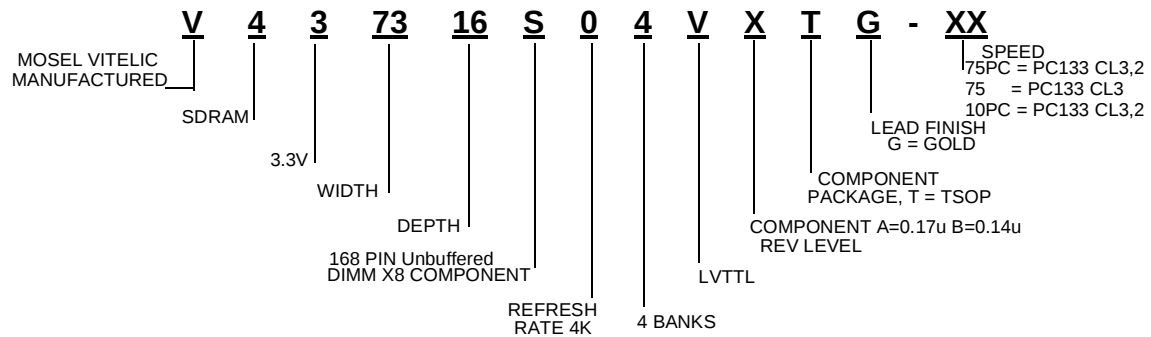
Pin	Front	Pin	Front	Pin	Front	Pin	Back	Pin	Back	Pin	Back
1	VSS	29	DQM1	57	I/O19	85	VSS	113	DQM5	141	I/O51
2	I/O1	30	$\overline{\text{CS0}}$	58	I/O20	86	I/O33	114	$\overline{\text{CS1}}$	142	I/O52
3	I/O2	31	DU	59	VCC	87	I/O34	115	RAS	143	VCC
4	I/O3	32	VSS	60	I/O21	88	I/O35	116	VSS	144	I/O53
5	I/O4	33	A0	61	NC	89	I/O36	117	A1	145	NC
6	VCC	34	A2	62	DU	90	VCC	118	A3	146	DU
7	I/O5	35	A4	63	CKE1	91	I/O37	119	A5	147	NC
8	I/O6	36	A6	64	VSS	92	I/O38	120	A7	148	VSS
9	I/O7	37	A8	65	I/O22	93	I/O39	121	A9	149	I/O54
10	I/O8	38	A10(AP)	66	I/O23	94	I/O40	122	BA0	150	I/O55
11	I/O9	39	BA1	67	I/O24	95	I/O41	123	A11	151	I/O56
12	VSS	40	VCC	68	VSS	96	VSS	124	VCC	152	VSS
13	I/O10	41	VCC	69	I/O25	97	I/O42	125	CLK1	153	I/O57
14	I/O11	42	CLK0	70	I/O26	98	I/O43	126	NC	154	I/O58
15	I/O12	43	VSS	71	I/O27	99	I/O44	127	VSS	155	I/O59
16	I/O13	44	DU	72	I/O28	100	I/O45	128	CKE0	156	I/O60
17	I/O14	45	$\overline{\text{CS2}}$	73	VCC	101	I/O46	129	$\overline{\text{CS3}}$	157	VCC
18	VCC	46	DQM2	74	I/O29	102	VCC	130	DQM6	158	I/O61
19	I/O15	47	DQM3	75	I/O30	103	I/O47	131	DQM7	159	I/O62
20	I/O16	48	DU	76	I/O31	104	I/O48	132	DU	160	I/O63
21	CB0	49	VCC	77	I/O32	105	CB4	133	VCC	161	I/O64
22	CB1	50	NC	78	VSS	106	CB5	134	NC	162	VSS
23	VSS	51	NC	79	CLK2	107	VSS	135	NC	163	CLK3
24	NC	52	CB2	80	NC	108	NC	136	CB6	164	NC
25	NC	53	CB3	81	WP	109	NC	137	CB7	165	SA0
26	VCC	54	VSS	82	SDA	110	VCC	138	VSS	166	SA1
27	$\overline{\text{WE}}$	55	I/O17	83	SCL	111	CAS	139	I/O49	167	SA2
28	DQM0	56	I/O18	84	VCC	112	DQM4	140	I/O50	168	VCC

Pin Names

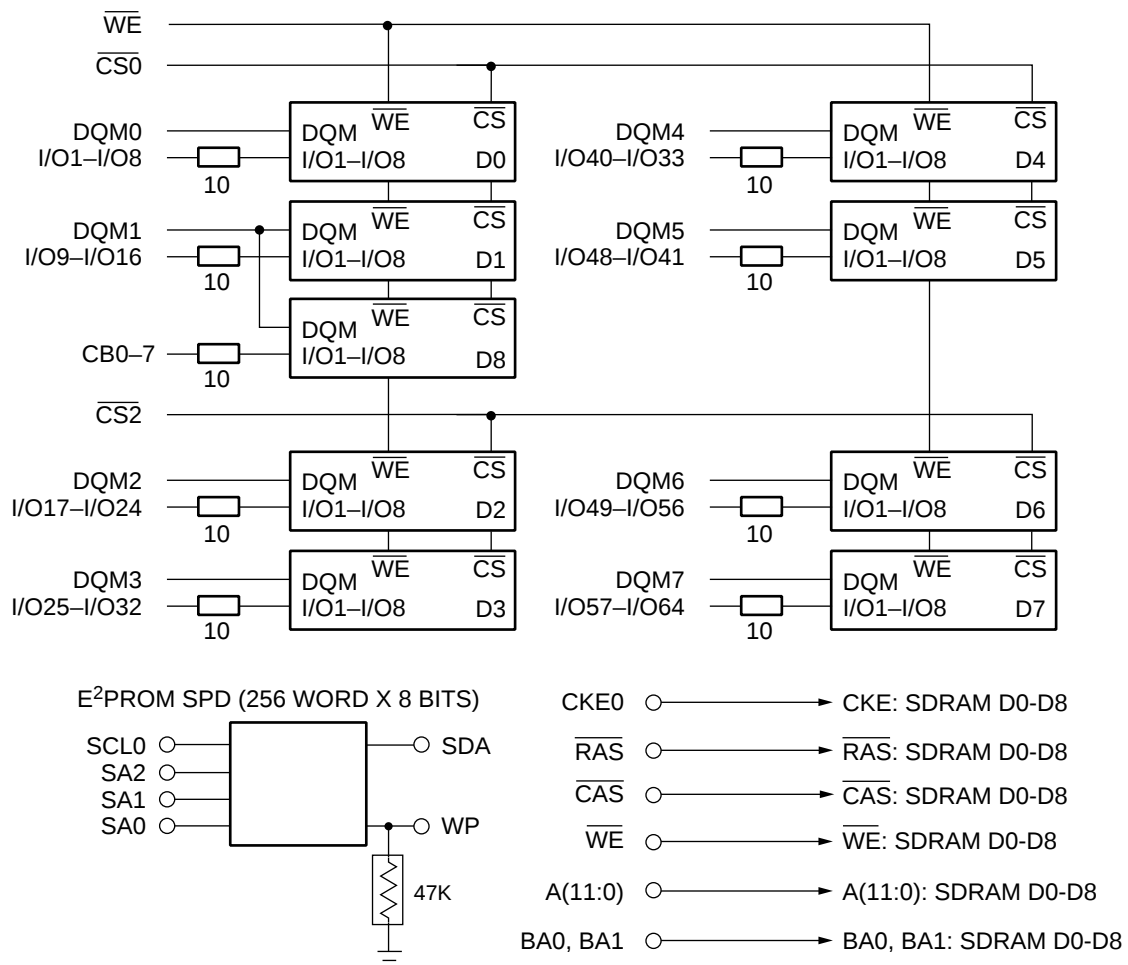
A0–A11	Address Inputs
I/O1–I/O64	Data Inputs/Outputs
$\overline{\text{RAS}}$	Row Address Strobe
$\overline{\text{CAS}}$	Column Address Strobe
$\overline{\text{WE}}$	Read/Write Input
BA0, BA1	Bank Selects
$\overline{\text{CKE0}}, \overline{\text{CKE1}}$	Clock Enable
$\overline{\text{CS0}}\text{--}\overline{\text{CS3}}$	Chip Select
CLK0–CLK3	Clock Input
DQM0–DQM7	Data Mask
VCC	Power (+3.3 Volts)
VSS	Ground
SCL	Clock for Presence Detect

SDA	Serial Data OUT for Presence Detect
SA0–A2	Serial Data IN for Presence Detect
CB0–CB7	Check Bits (x72 Organization)
NC	No Connection
DU	Don't Use

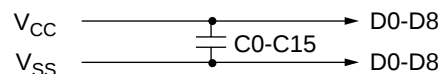
Part Number Information



Block Diagram



CLOCK WIRING	
CLOCK INPUT	LOAD
CLK0	5 SDRAMS
CLK1	Termination
CLK2	4 SDRAMS +3.3pF Cap
CLK3	Termination



V437316S04VTG-75-03

Serial Presence Detect Information

A serial presence detect storage device - E²PROM - is assembled onto the module. Information about the module configuration, speed, etc. is

written into the E²PROM device during module production using a serial presence detect protocol (I²C synchronous 2-wire bus)

SPD-Table

Byte Number	Function Described	SPD Entry Value	Hex Value		
			-75PC	-75	-10PC
0	Number of SPD bytes	128	80	80	80
1	Total bytes in Serial PD	256	08	08	08
2	Memory Type	SDRAM	04	04	04
3	Number of Row Addresses (without BS bits)	12	0C	0C	0C
4	Number of Column Addresses (for x8 SDRAM)	10	0A	0A	0A
5	Number of DIMM Banks	1	01	01	01
6	Module Data Width	72	48	48	48
7	Module Data Width (continued)	0	00	00	00
8	Module Interface Levels	LVTTL	01	01	01
9	SDRAM Cycle Time at CL=3	7.5 ns	75	75	A0
10	SDRAM Access Time from Clock at CL=3	5.4 ns	54	54	60
11	Dimm Config (Error Det/Corr.)	ECC	02	02	02
12	Refresh Rate/Type	Self-Refresh, 15.6μs	80	80	80
13	SDRAM width, Primary	x8	08	08	08
14	Error Checking SDRAM Data Width	n/a / x8	08	08	08
15	Minimum Clock Delay from Back to Back Random Column Address	t _{ccd} = 1 CLK	01	01	01
16	Burst Length Supported	1, 2, 4, 8	0F	0F	0F
17	Number of SDRAM Banks	4	04	04	04
18	Supported $\overline{\text{CAS}}$ Latencies	CL = 3	06	06	06
19	$\overline{\text{CS}}$ Latencies	$\overline{\text{CS}}$ Latency = 0	01	01	01
20	$\overline{\text{WE}}$ Latencies	WL = 0	01	01	01
21	SDRAM DIMM Module Attributes	Non Buffered/Non Reg.	00	00	00
22	SDRAM Device Attributes: General	Vcc tol ± 10%	0E	0E	0E
23	Minimum Clock Cycle Time at $\overline{\text{CAS}}$ Latency = 2	Not Supported	75	A0	A0
24	Maximum Data Access Time from Clock for CL = 2	Not Supported	54	60	60
25	Minimum Clock Cycle Time at CL = 1	Not Supported	00	00	00
26	Maximum Data Access Time from Clock at CL = 1	Not Supported	00	00	00
27	Minimum Row Precharge Time	20 ns	0F	14	14

SPD-Table

Byte Number	Function Described	SPD Entry Value	Hex Value		
			-75PC	-75	-10PC
28	Minimum Row Active to Row Active Delay t_{RRD}	15 ns	0E	0F	10
29	Minimum RAS to $\overline{\text{CAS}}$ Delay t_{RCD}	20 ns	0F	14	14
30	Minimum RAS Pulse Width t_{RAS}	45 ns	2A	2D	2D
31	Module Bank Density (Per Bank)	128 MByte	20	20	20
32	SDRAM Input Setup Time	1.5 ns	15	15	20
33	SDRAM Input Hold Time	0.8 ns	08	08	10
34	SDRAM Data Input Setup Time	1.5 ns	15	15	20
35	SDRAM Data Input Hold Time	0.8 ns	08	08	10
36-61	Superset Information (May be used in Future)		00	00	00
62	SPD Revision	Revision 2	02	02	02
63	Checksum for Bytes 0 - 62		EC	31	8F
64	Manufacturer's JEDEC ID Code	Mosel Vitelic	40	40	40
65-71	Manufacturer's JEDEC ID Code (cont.)		00	00	00
72	Manufacturing Location				
73-90	Module Part Number (ASCII)	V437316S04V			
91-92	PCB Identification Code				
93	Assembly Manufacturing Date (Year)				
94	Assembly Manufacturing Date (Week)				
95-98	Assembly Serial Number				
99-125	Reserved		00	00	00
126	Intel Specification for Frequency		64	64	64
127	Reserved		00	00	00
128+	Unused Storage Location		00	00	00

DC Characteristics

$T_A = 0^\circ\text{C}$ to 70°C ; $V_{SS} = 0\text{ V}$; V_{DD} , $V_{DDQ} = 3.3\text{V} \pm 0.3\text{V}$

Symbol	Parameter	Limit Values		Unit
		Min.	Max.	
V_{IH}	Input High Voltage	2.0	$V_{CC}+0.3$	V
V_{IL}	Input Low Voltage	-0.5	0.8	V
V_{OH}	Output High Voltage ($I_{OUT} = -2.0\text{ mA}$)	2.4	—	V
V_{OL}	Output Low Voltage ($I_{OUT} = 2.0\text{ mA}$)	—	0.4	V

Symbol	Parameter	Limit Values		Unit
		Min.	Max.	
$I_{I(L)}$	Input Leakage Current, any input ($0\text{ V} < V_{IN} < 3.6\text{ V}$, all other inputs = 0V)	-40	40	μA
$I_{O(L)}$	Output leakage current (DQ is disabled, $0\text{V} < V_{OUT} < V_{CC}$)	-40	40	μA

Capacitance

$T_A = 0^\circ\text{C}$ to 70°C ; $V_{DD} = 3.3\text{V} \pm 0.3\text{V}$, $f = 1\text{ MHz}$

Symbol	Parameter	Limit Values	Unit
		Max. 16M x 72	
C_{I1}	Input Capacitance (A0 to A11, $\overline{\text{RAS}}$, $\overline{\text{CAS}}$, $\overline{\text{WE}}$)	65	pF
C_{I2}	Input Capacitance ($\overline{\text{CS0}}$ - $\overline{\text{CS3}}$)	40	pF
C_{ICL}	Input Capacitance (CLK0-CLK3)	40	pF
C_{I3}	Input Capacitance (CKE0, CKE1)	55	pF
C_{I4}	Input Capacitance (DQM0-DQM7)	20	pF
C_{IO}	Input/Output Capacitance (I/O1-I/O64)	20	pF
C_{SC}	Input Capacitance (SCL, SA0-2)	8	pF
C_{SD}	Input/Output Capacitance (SA0-SA2)	10	pF

Absolute Maximum Ratings

Parameter	Max.	Units
Voltage on VDD Supply Relative to V_{SS}	-1 to 4.6	V
Voltage on Input Relative to V_{SS}	-1 to 4.6	V
Operating Temperature	0 to +70	$^\circ\text{C}$
Storage Temperature	-55 to 125	$^\circ\text{C}$
Power Dissipation	7.5	W

Operating Currents

$T_A = 0^\circ\text{C}$ to 70°C , $V_{CC} = 3.3\text{V} \pm 0.3\text{V}$ (Recommended operating conditions otherwise noted)

Symbol	Parameter & Test Condition		Max.		Unit	Note
			-75PC/-75	-10PC		
ICC1	Operating Current $t_{RC} = t_{RCMIN}$, $t_{RC} = t_{CKMIN}$ Active-precharge command cycling, without Burst Operation	1 bank operation	1800	1350	mA	7

Operating Currents

$T_A = 0^\circ\text{C}$ to 70°C , $V_{CC} = 3.3\text{V} \pm 0.3\text{V}$ (Recommended operating conditions otherwise noted) (Continued)

Symbol	Parameter & Test Condition		Max.		Unit	Note
			-75PC/-75	-10PC		
ICC2P	Precharge Standby Current in Power Down Mode $\overline{CS} = V_{IH}$, $CKE \leq V_{IL(max)}$	$t_{CK} = \text{min.}$	14	14	mA	7
ICC2PS		$t_{CK} = \text{Infinity}$	9	9	mA	7
ICC2N	Precharge Standby Current in Non-Power Down Mode $\overline{CS} = V_{IH}$, $CKE \geq V_{IL(max)}$	$t_{CK} = \text{min.}$	400	315	mA	
ICC2NS		$t_{CK} = \text{Infinity}$	45	45	mA	
ICC3	No Operating Current $t_{CK} = \text{min}$, $\overline{CS} = V_{IH(min)}$ bank ; active state (4 banks)	$CKE \geq V_{IH(MIN.)}$	495	405	mA	
ICC3P		$CKE \geq V_{IL(MAX.)}$ (Power down mode)	90	90	mA	
ICC4	Burst Operating Current $t_{CK} = \text{min}$ Read/Write command cycling		990	810	mA	7,8
ICC5	Auto Refresh Current $t_{CK} = \text{min}$ Auto Refresh command cycling		2250	1890	mA	7
ICC6	Self Refresh Current Self Refresh Mode, $CKE=0.2V$		14	14	mA	
		L-version	7.2	7.2	mA	

Notes:

- These parameters depend on the cycle rate and these values are measured by the cycle rate under the minimum value of t_{CK} and t_{RC} . Input signals are changed one time during t_{CK} .
- These parameter depend on output loading. Specified values are obtained with output open.

AC Characteristics

$T_A = 0^\circ$ to 70°C ; $V_{SS} = 0V$; $V_{CC} = 3.3V \pm 0.3V$, $t_T = 1\text{ ns}$

#	Symbol	Parameter	Limit Values						Unit	Note
			-75PC		-75		-10PC			
			Min.	Max.	Min.	Max.	Min.	Max.		
Clock and Clock Enable										
1	t _{CK}	Clock Cycle Time CAS Latency = 3 CAS Latency = 2	7.5 7.5	– –	7.5 10	– –	10 10	– –	s ns ns	
2	t _{CK}	Clock Frequency CAS Latency = 3 CAS Latency = 2	– –	133 133	– –	133 100	– –	100 100	MHz MHz	
3	t _{AC}	Access Time from Clock CAS Latency = 3 CAS Latency = 2	– –	5.4 6	– –	5.4 6	– –	6 6	ns ns	2, 4
4	t _{CH}	Clock High Pulse Width	2.5	–	2.5	–	2.5	–	ns	

AC Characteristics

$T_A = 0^\circ$ to 70°C ; $V_{SS} = 0\text{V}$; $V_{CC} = 3.3\text{V} \pm 0.3\text{V}$, $t_T = 1\text{ ns}$ (Continued)

#	Symbol	Parameter	Limit Values						Unit	Note
			-75PC		-75		-10PC			
			Min.	Max.	Min.	Max.	Min.	Max.		
5	t _{CL}	Clock Low Pulse Width	2.5	—	2.5	—	2.5	—	ns	
6	t _T	Transition Tim	1	—	1	—	1	—	ns	

Setup and Hold Times

7	t_{IS}	Input Setup Time	1.5	—	1.5	—	1.5	—	ns	5
8	t_{IH}	Input Hold Time	0.8	—	0.8	—	0.8	—	ns	5
9	t_{CKS}	Input Setup Time	1.5	—	1.5	—	1.5	—	ns	5
10	t_{CKH}	CKE Hold Time	0.8	—	0.8	—	0.8	—	ns	5
11	t_{RSC}	Mode Register Set-up Time	15	—	15	—	15	—	ns	
12	t_{SB}	Power Down Mode Entry Time	0	7.5	0	7.5	0	7.5	ns	

Common Parameters

13	t_{RCD}	Row to Column Delay Time	15	—	20	—	20	—	ns	6
14	t_{RP}	Row Precharge Time	20	—	20	—	20	—	ns	6
15	t_{RAS}	Row Active Time	42	100K	45	100K	45	100K	ns	6
16	t_{RC}	Row Cycle Time	60	—	70	—	70	—	ns	6
17	t_{RRD}	Activate(a) to Activate(b) Command Period	14	—	15	—	20	—	ns	6
18	t_{CCD}	$\overline{\text{CAS}}$ (a) to $\overline{\text{CAS}}$ (b) Command Period	1	—	1	—	1	—	CLK	

Refresh Cycle

19	t_{REF}	Refresh Period (4096 cycles)	—	64	—	64	—	64	ms	
20	t_{SREX}	Self Refresh Exit Time	10	—	10	—	10	—	ns	

Read Cycle

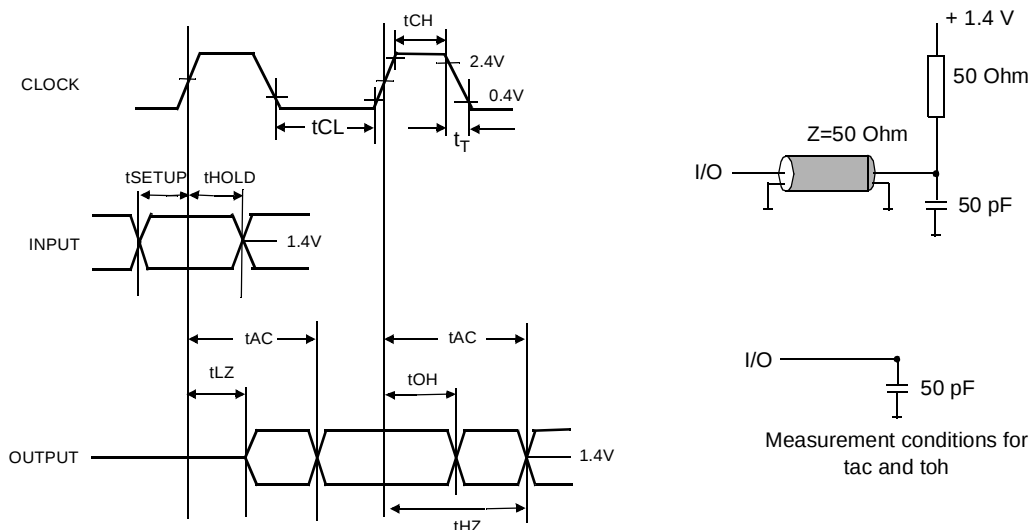
21	t_{OH}	Data Out Hold Time	3	—	3	—	3	—	ns	2
22	t_{LZ}	Data Out to Low Impedance Time	0	—	0	—	0	—	ns	
23	t_{HZ}	Data Out to High Impedance Time	3	7.5	3	7.5	3	8	ns	7
24	t_{DQZ}	DQM Data Out Disable Latency	2	—	2	—	2	—	CLK	

Write Cycle

25	t_{WR}	Write Recovery Time	2	—	2	—	1	—	CLK	
26	t_{DQW}	DQM Write Mask Latency	0	—	0	—	0	—	CLK	

Notes:

1. The specified values are valid when addresses are changed no more than once during $t_{CK}(\text{min.})$ and when No Operation commands are registered on every rising clock edge during $t_{RC}(\text{min.})$. Values are shown per module bank.
2. The specified values are valid when data inputs (DQ's) are stable during $t_{RC}(\text{min.})$.
3. All AC characteristics are shown for device level.
An initial pause of 100 μs is required after power-up, then a Precharge All Banks command must be given followed by 8 Auto Refresh (CBR) cycles before the Mode Register Set Operation can begin.
4. AC timing tests have $V_{IL} = 0.4\text{V}$ and $V_{IH} = 2.4\text{V}$ with the timing referenced to the 1.4V crossover point. The transition time is measured between V_{IH} and V_{IL} . All AC measurements assume $t_T = 1\text{ ns}$ with the AC output load circuit shown. Specific t_{AC} and t_{OH} parameters are measured with a 50 pF only, without any resistive termination and with a input signal of 1V / ns edge rate between 0.8V and 2.0V.

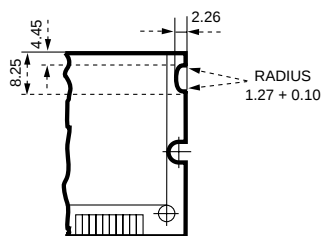
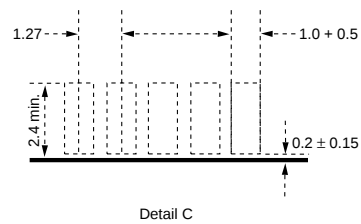
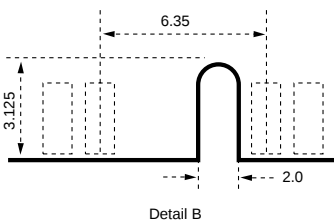
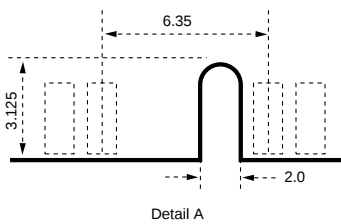
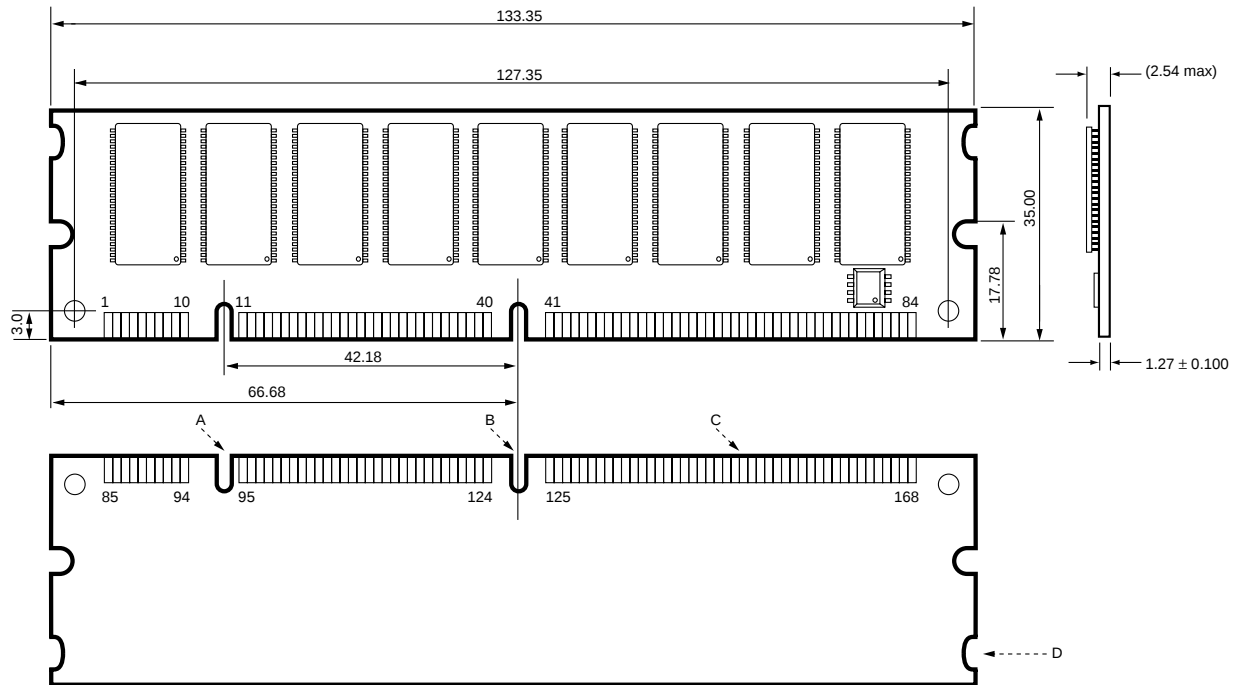


5. If clock rising time is longer than 1 ns, a time $(t_T/2 - 0.5)$ ns has to be added to this parameter.
6. Rated at 1.5V
7. If t_T is longer than 1 ns, a time $(t_T - 1)$ ns has to be added to this parameter.
8. Any time that the refresh Period has been exceeded, a minimum of two Auto (CBR) Refresh commands must be given to "wake-up" the device.
9. Self Refresh Exit is a synchronous operation and begins on the 2nd positive clock edge after CKE returns high. Self Refresh Exit is not complete until a time period equal to t_{RC} is satisfied once the Self Refresh Exit command is registered.
10. Referenced to the time which the output achieves the open circuit condition, not to output voltage levels.
11. t_{DAL} is equivalent to $t_{DPL} + t_{RP}$.

Package Diagram

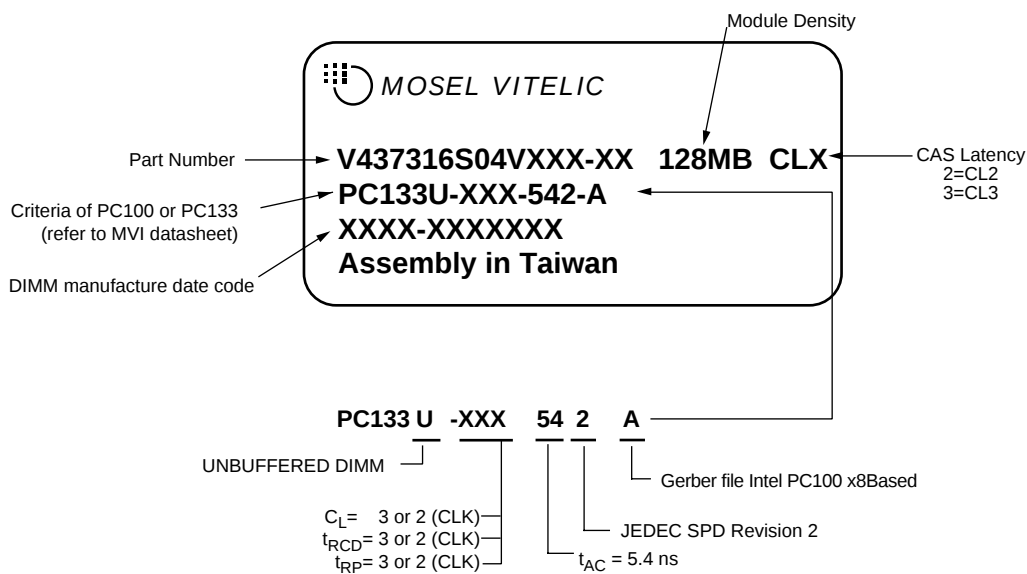
SDRAM DIMM Module Package

All measurements in mm



V437316S04VTG-75-04

Tolerances: ± (0.13) unless otherwise specified.

Label Information


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- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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